<table>
<thead>
<tr>
<th>Symbol</th>
<th>Hit Count</th>
<th>Tool Size</th>
<th>Plated Hole Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>L</td>
<td>17</td>
<td>0.0254in (0.65mm)</td>
<td>PTH Round</td>
</tr>
<tr>
<td>N</td>
<td>13</td>
<td>0.016in (0.4mm)</td>
<td>PTH Round</td>
</tr>
<tr>
<td>W</td>
<td>36</td>
<td>0.0236in (0.6mm)</td>
<td>PTH Round</td>
</tr>
<tr>
<td>K</td>
<td>28</td>
<td>0.0156in (0.4mm)</td>
<td>PTH Round</td>
</tr>
<tr>
<td>M</td>
<td>10</td>
<td>0.0254in (0.65mm)</td>
<td>PTH Round</td>
</tr>
</tbody>
</table>

Drill Table

SHELL TOLERANCE
FOR PTH +/- .001
.0874in (2.22mm)
.0937in (2.38mm)
.1001in (2.54mm)
.1064in (2.70mm)
.1127in (2.87mm)

TOLERANCES ON HOLE AREAS
1.000in (25.4mm)
1.062in (26.99mm)

ALL ARTWORK VISIBLE FROM TOP SIDE
BOARD # TYPE: 000010 BBA1 01 LSN HOLE IN VERTA/CLIP

LAYER NAME: Drill Drawing

PLOT HOLE DRILL DRAWING
GENERATED: 1/30/2010 1:34:16 PM TEXAS INSTRUMENTS
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